

Product Summary

V_{RRM} (V)	I_O (A)	V_F max (V)	I_R max (mA)
60	10	0.52	0.4

Description

Packaged in the robust industry-standard TO252 (DPAK) package, the SBRT10U60D1 provides very low V_F and excellent reverse leakage stability at high temperatures.



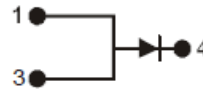
Top View

Features and Benefits

- Reduced Ultra-Low Forward Voltage Drop (V_F). Better Efficiency and Cooler Operation.
- Reduced High Temperature Reverse Leakage. Increased Reliability Against Thermal Runaway Failure in High Temperature Operation.
- Moisture Sensitivity: Level 1 per J-STD-020
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Mechanical Data

- Case: TO252 (DPAK)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish. Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.4 grams (Approximate)



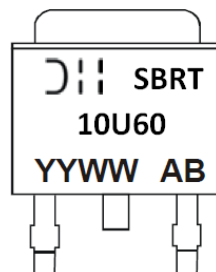
Package Pin-Out Configuration

Ordering Information (Note 4)

Part Number	Case	Packaging
SBRT10U60D1-13	TO252 (DPAK)	2500 pieces/reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



SBRT10U60 = Product Type Marking Code
 AB = Foundry and Assembly Code
 YYWW = Date Code Marking
 YY = Last Two Digits of Year (ex: 16 = 2016)
 WW = Week (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
 For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	60	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _{RM}		
Average Rectified Output Current	I _O	10	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	140	A

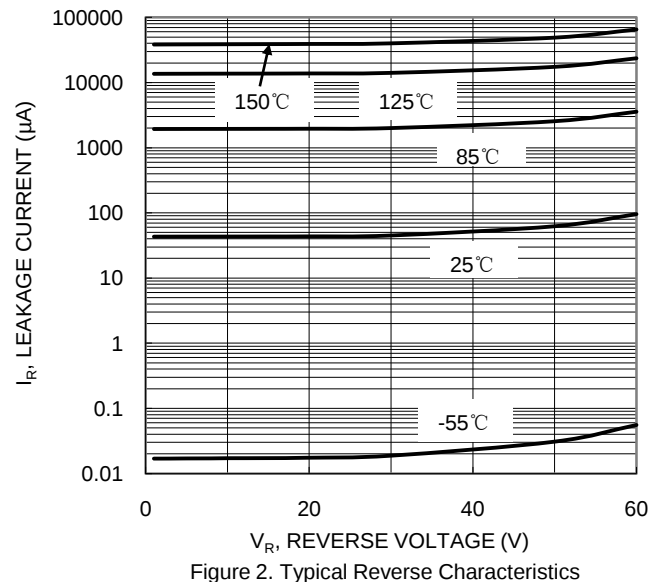
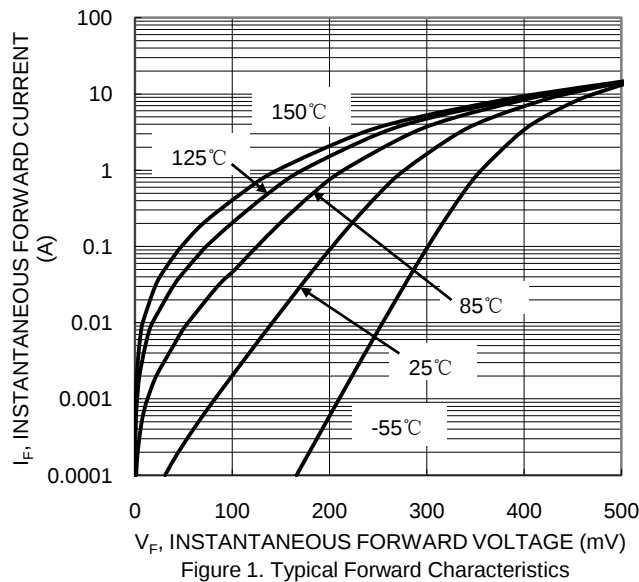
Thermal Characteristics (Per Leg)

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	R _{θJA}	18	°C/W
Typical Thermal Resistance Junction to Case (Note 5)	R _{θJC}	2	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (Per Leg) (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V _F	—	0.44	0.52 0.50	V	I _F = 10A, T _J = +25°C I _F = 10A, T _J = +125°C
Leakage Current (Note 6)	I _R	—	0.08	0.4 70	mA mA	V _R = 60V, T _J = +25°C V _R = 60V, T _J = +125°C

Notes: 5. 2inch*2inch Al board, minimum recommended pad layout as shown in Diodes Incorporated's package outline PDFs, which can be found on our website at <http://www.diodes.com/package-outlines.html>.
 6. Short duration pulse test used to minimize self-heating effect.



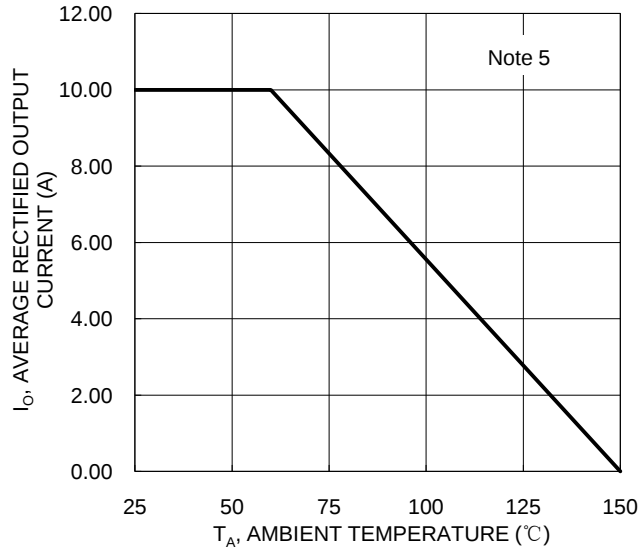


Figure 3. DC Forward Current Derating

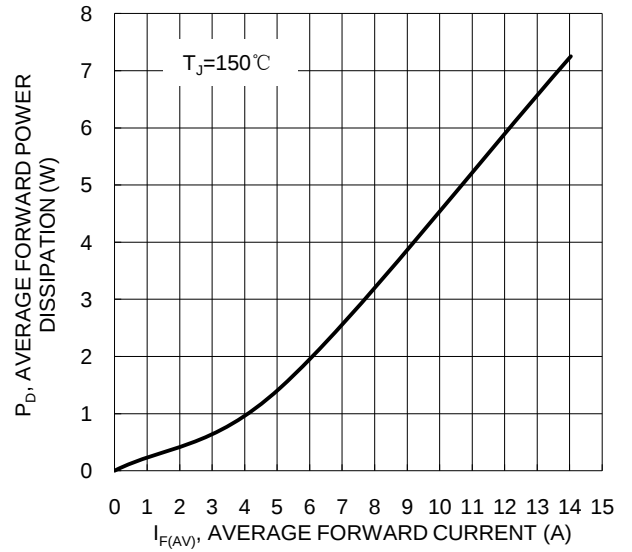


Figure 4. Forward Power Dissipation

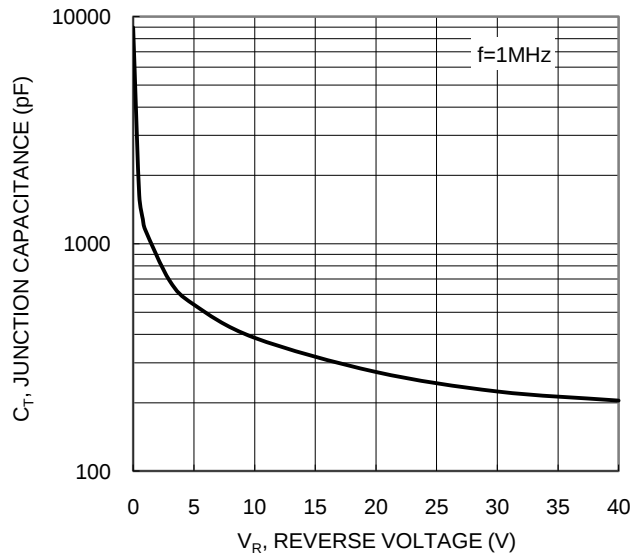
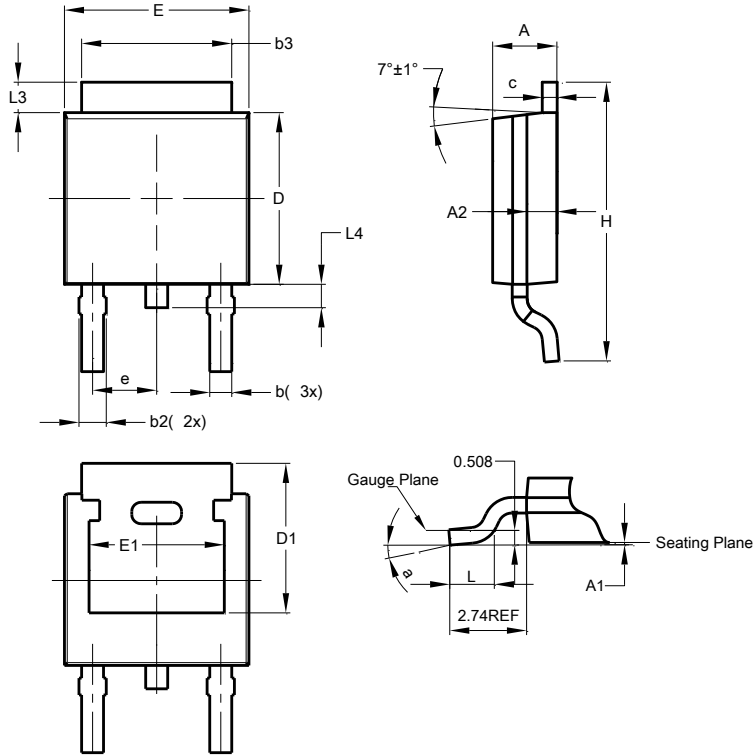


Figure 5. Typical Junction Capacitance

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

TO252 (DPAK)

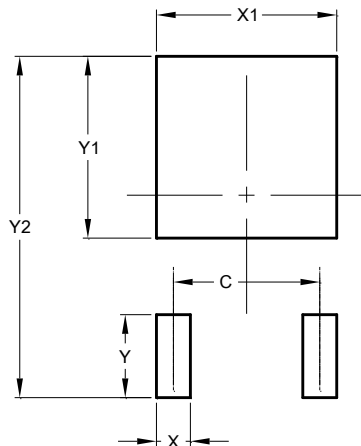


TO252 (DPAK)			
Dim	Min	Max	Typ
A	2.19	2.39	2.29
A1	0.00	0.13	0.08
A2	0.97	1.17	1.07
b	0.64	0.88	0.783
b2	0.76	1.14	0.95
b3	5.21	5.46	5.33
c	0.45	0.58	0.531
D	6.00	6.20	6.10
D1	5.21	-	-
e	-	-	2.286
E	6.45	6.70	6.58
E1	4.32	-	-
H	9.40	10.41	9.91
L	1.40	1.78	1.59
L3	0.88	1.27	1.08
L4	0.64	1.02	0.83
a	0°	10°	-
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

TO252 (DPAK)



Dimensions	Value (in mm)
C	4.572
X	1.060
X1	5.632
Y	2.600
Y1	5.700
Y2	10.700

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